BUK7908-40AIE



N-channel TrenchPLUS standard level FET

Rev. 03 — 17 February 2009

Product data sheet

1. Product profile

1.1 General description

Standard level N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using TrenchMOS technology. The devices include TrenchPLUS current sensing and diodes for ElectroStatic Discharge (ESD) protection. This product has been designed and qualified to the appropriate AEC standard for use in automotive critical applications.

1.2 Features and benefits

- Electrostatically robust due to integrated protection diodes
- Low conduction losses due to low on-state resistance
- Q101 compliant

- Reduced component count due to integrated current sensor
- Suitable for standard level gate drive sources

1.3 Applications

Electrical Power Assisted Steering (EPAS) Variable Valve Timing for engines

1.4 Quick reference data

Table 1. Quick reference

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V_{DS}	drain-source voltage	$T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}$		-	-	40	V
I _D	drain current	$V_{GS} = 10 \text{ V}; T_{mb} = 25 \text{ °C};$ see <u>Figure 2</u> ; see <u>Figure 3</u>	[1]	-	-	117	Α
Static ch	naracteristics						
R _{DSon}	drain-source on-state resistance	$V_{GS} = 10 \text{ V}; I_D = 50 \text{ A};$ $T_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure 7}}{\text{see } \frac{\text{Figure 8}}{\text{Figure 8}}}$		-	6	8	mΩ
I _D /I _{sense}	ratio of drain current to sense current	$T_j > -55 \text{ °C}; T_j < 175 \text{ °C}; V_{GS} > 10 \text{ V}$		450	500	550	

^[1] Current is limited by power dissipation chip rating.



2. Pinning information

Table 2. Pinning information

Symbol G ISENSE	Description gate	Simplified outline	Graphic symbol	
	gate			
ISENSE			d	
	sense current	mb T	, i	
D	drain			
KS	Kelvin source			
S	source			
	D mounting base; connected to drain			MBL368 Isense Kelvin source
		SOT263B (TO-220)		
	KS S	D drain KS Kelvin source S source D mounting base; connected to	D drain KS Kelvin source S source D mounting base; connected to drain	

3. Ordering information

Table 3. Ordering information

Type number	Package	Package					
	Name	Description	Version				
BUK7908-40AIE	TO-220	plastic single-ended package; heatsink mounted; 1 mounting hole; 5-lead TO-220	SOT263B				

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C		-	40	V
V_{DGR}	drain-gate voltage	$R_{GS} = 20 \text{ k}\Omega$		-	40	V
V_{GS}	gate-source voltage			-20	20	V
I_D	drain current	T_{mb} = 25 °C; V_{GS} = 10 V; see <u>Figure 2</u> ;	[1]	-	117	Α
		see Figure 3	[2]	-	75	Α
		T _{mb} = 100 °C; V _{GS} = 10 V; see <u>Figure 2</u>	[2]	-	75	Α
I _{DM}	peak drain current	T_{mb} = 25 °C; $t_p \le 10 \mu s$; pulsed; see <u>Figure 3</u>		-	468	Α
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 1</u>		-	221	W
I _{GS(CL)}	gate-source clamping	continuous		-	10	mA
	current	pulsed; $t_p = 5 \text{ ms}$; $\delta = 0.01$		-	50	mA
T _{stg}	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
Source-dr	ain diode					
Is	source current	$T_{mb} = 25 ^{\circ}C$	[1]	-	117	Α
			[2]	-	75	Α
I _{SM}	peak source current	$t_p \le 10 \mu\text{s}; \text{ pulsed}; T_{mb} = 25 ^{\circ}\text{C}$		-	468	Α
Avalanche	ruggedness					
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	I_D = 75 A; $V_{sup} \le$ 40 V; R_{GS} = 50 Ω ; V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; unclamped		-	0.63	J
Electrosta	tic discharge					
V _{esd}	electrostatic discharge voltage	HBM; C = 100 pF; R = 1.5 kΩ		-	6	kV

^[1] Current is limited by power dissipation chip rating.

^[2] Continuous current is limited by package.

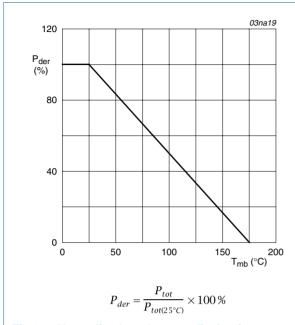


Fig 1. Normalized total power dissipation as a function of mounting base temperature

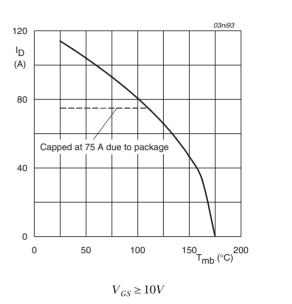


Fig 2. Normalized continuous drain current as a function of mounting base temperature

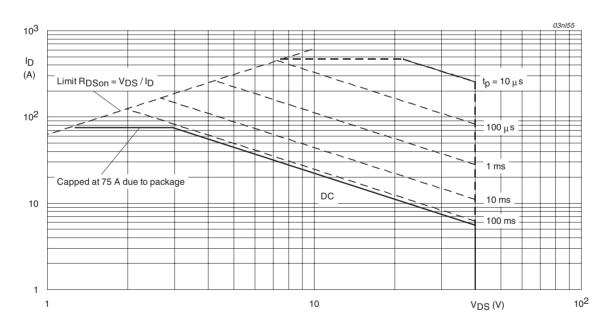


Fig 3. Safe operating area; continuous and peak drain currents as a function of drain-source voltage

 $T_{mb} = 25$ °C; I_{DM} is single pulse

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	vertical in still air	-	60	-	K/W
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	see Figure 4	-	-	0.68	K/W

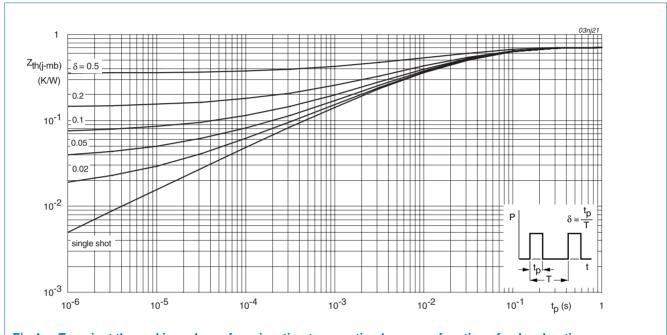


Fig 4. Transient thermal impedance from junction to mounting base as a function of pulse duration

6. Characteristics

Table 6. Characteristics

Table 6.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
$V_{(BR)DSS}$	drain-source	$I_D = 0.25 \text{ mA}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	40	-	-	V
	breakdown voltage	$I_D = 0.25 \text{ mA}; V_{GS} = 0 \text{ V}; T_j = -55 \text{ °C}$	36	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	$I_D = 1$ mA; $V_{DS} = V_{GS}$; $T_j = 25$ °C; see Figure 9	2	3	4	V
		$I_D = 1$ mA; $V_{DS} = V_{GS}$; $T_j = 175$ °C; see Figure 9	1	-	-	V
		$I_D = 1$ mA; $V_{DS} = V_{GS}$; $T_j = -55$ °C; see <u>Figure 9</u>	-	-	4.4	V
I _{DSS}	drain leakage current	$V_{DS} = 40 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	0.1	10	μΑ
		$V_{DS} = 40 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 175 \text{ °C}$	-	-	250	μΑ
V _{(BR)GSS} gate-source breakdown voltage		$I_G = 1 \text{ mA}; V_{DS} = 0 \text{ V}; T_j > -55 \text{ °C};$ $T_j < 175 \text{ °C}$	20	22	-	V
		$I_G = -1 \text{ mA}; V_{DS} = 0 \text{ V}; T_j > -55 \text{ °C};$ $T_j < 175 \text{ °C}$	20	22	-	V
I _{GSS}	gate leakage current	$V_{DS} = 0 \text{ V}; V_{GS} = 10 \text{ V}; T_j = 25 \text{ °C}$	-	22	300	nΑ
		$V_{DS} = 0 \text{ V}; V_{GS} = -10 \text{ V}; T_j = 25 \text{ °C}$	-	22	300	nΑ
		V _{DS} = 0 V; V _{GS} = 10 V; T _j = 175 °C	-	-	10	μΑ
		V _{DS} = 0 V; V _{GS} = -10 V; T _j = 175 °C	-	-	10	μΑ
R _{DSon} drain-source resistance	drain-source on-state resistance	V_{GS} = 10 V; I_D = 50 A; T_j = 25 °C; see <u>Figure 7</u> ; see <u>Figure 8</u>	-	6	8	mΩ
		$V_{GS} = 10 \text{ V}$; $I_D = 50 \text{ A}$; $T_j = 175 \text{ °C}$; see Figure 7; see Figure 8	-	-	15.2	mΩ
R _(D-ISENSE)	drain-ISENSE on-state	$V_{GS} = 10 \text{ V}; I_D = 10 \text{ mA}; T_j = 25 \text{ °C}$	1.59	1.87	2.2	Ω
on	resistance	$V_{GS} = 10 \text{ V}; I_D = 10 \text{ mA}; T_j = 175 \text{ °C}$	3.02	3.55	4.18	Ω
I _D /I _{sense}	ratio of drain current to sense current	$V_{GS} > 10 \text{ V; } T_j > -55 \text{ °C; } T_j < 175 \text{ °C}$	450	500	550	
Dynamic o	haracteristics					
Q _{G(tot)}	total gate charge	$I_D = 25 \text{ A}; V_{DS} = 32 \text{ V}; V_{GS} = 10 \text{ V};$	-	78	84	nC
Q_{GS}	gate-source charge	T _j = 25 °C; see <u>Figure 14</u>	-	14	16	nC
Q_{GD}	gate-drain charge		-	34	36	nC
C _{iss}	input capacitance	$V_{GS} = 0 \text{ V}; V_{DS} = 25 \text{ V}; f = 1 \text{ MHz};$	-	2670	3140	pF
C _{oss}	output capacitance	T _j = 25 °C; see <u>Figure 12</u>	-	900	1053	pF
C _{rss}	reverse transfer capacitance		-	560	653	pF
t _{d(on)}	turn-on delay time	$V_{DS} = 30 \text{ V}; R_L = 1.2 \Omega; V_{GS} = 10 \text{ V};$	-	19	-	ns
t _r	rise time	$R_{G(ext)}$ 10 Ω ; $T_j = 25$ °C	-	76	-	ns
t _{d(off)}	turn-off delay time		-	121	-	ns
t _f	fall time		-	122	-	ns

N-channel TrenchPLUS standard level FET

Table 6. Characteristics ... continued

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
L _D	internal drain inductance	from upper edge of drain mounting base to centre of die; $T_j = 25$ °C	-	2.5	-	nΗ
L _S	internal source inductance	from source lead to source bond pad; $T_j = 25 ^{\circ}\text{C}$; lead length 6 mm	-	7.5	-	nΗ
Source-di	rain diode					
V_{SD}	source-drain voltage	$I_S = 40 \text{ A}$; $V_{GS} = 0 \text{ V}$; $T_j = 25 \text{ °C}$; see Figure 17	-	0.85	1.2	V
t _{rr}	reverse recovery time	$I_S = 20 \text{ A}$; $dI_S/dt = -100 \text{ A/}\mu\text{s}$; $V_{GS} = -10 \text{ V}$;	-	55	-	ns
Q _r	recovered charge	$V_{DS} = 30 \text{ V; } T_j = 25 ^{\circ}\text{C}$	-	30	-	nC

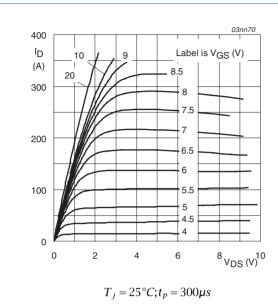
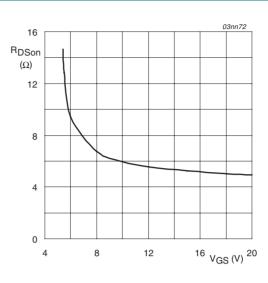


Fig 5. Output characteristics: drain current as a function of drain-source voltage; typical values



 $T_j = 25$ °C; $I_D = 50A$

Fig 6. Drain-source on-state resistance as a function of gate-source voltage; typical values

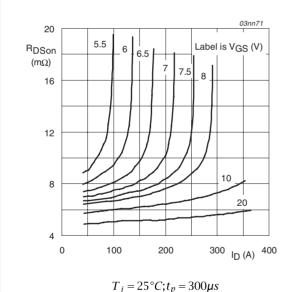


Fig 7. Drain-source on-state resistance as a function of drain current; typical values

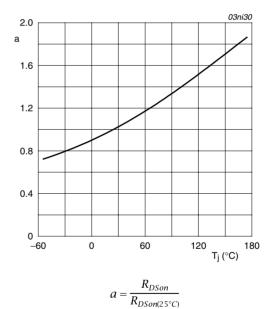
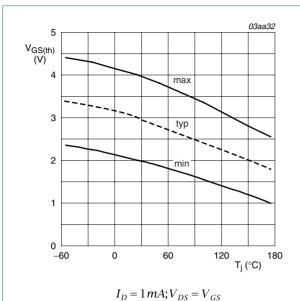
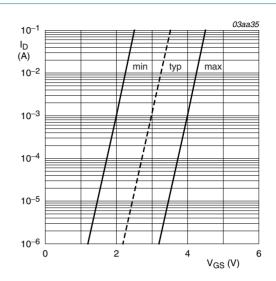


Fig 8. Normalized drain-source on-state resistance factor as a function of junction temperature

Fig 9.



Gate-source threshold voltage as a function of junction temperature



 $T_j = 25\,^{\circ}C; V_{DS} = 5V$

Fig 10. Sub-threshold drain current as a function of gate-source voltage

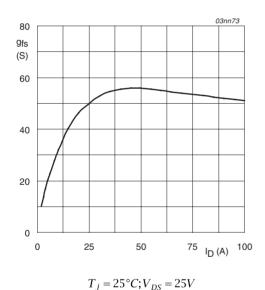


Fig 11. Forward transconductance as a function of drain current; typical values

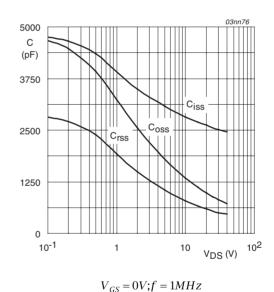


Fig 12. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

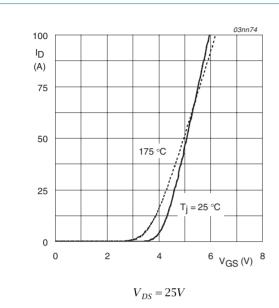


Fig 13. Transfer characteristics: drain current as a function of gate-source voltage; typical values

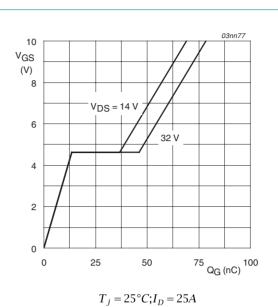


Fig 14. Gate-source voltage as a function of charge; typical values

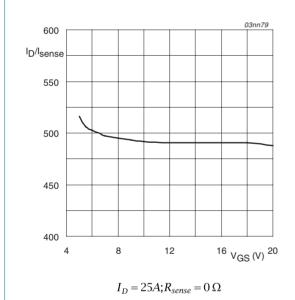


Fig 15. Drain-sense current ratio as a function of gate-source voltage; typical values

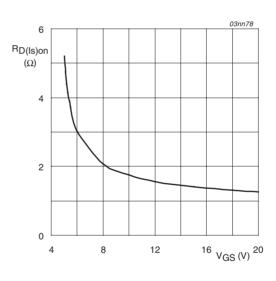
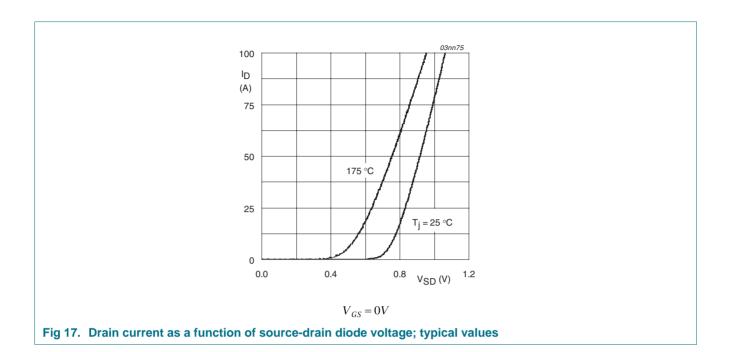


Fig 16. Drain-sense current on-state resistance as a function of gate-source voltage; typical values

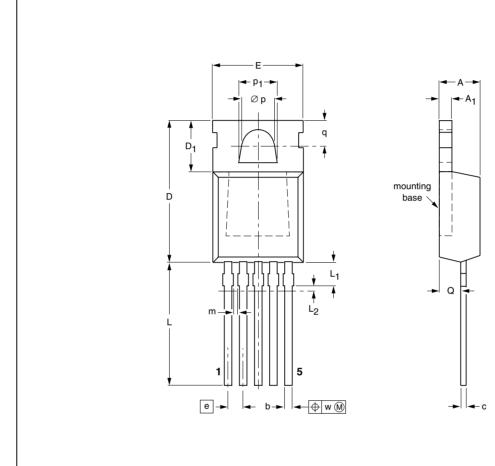
 $I_{sense} = 25mA$

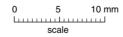


7. Package outline

Plastic single-ended package; heatsink mounted; 1 mounting hole; 5-lead TO-220

SOT263B





DIMENSIONS (mm are the original dimensions)

UNIT	A	A ₁	b	С	D	D ₁	E	е	L	L ₁ ⁽¹⁾	L ₂ ⁽²⁾	m	∅p	P ₁	q	Q	w	
mm	4.5 4.1	1.39 1.27	0.85 0.70	0.7 0.4	15.8 15.2	6.4 5.9	10.3 9.7	1.7	15.0 13.5	2.4 1.6	0.5	0.8 0.6	3.8 3.6	4.3 4.1	3.0 2.7	2.6 2.2	0.4	

Notes

- 1. Terminal dimensions are uncontrolled in this zone.
- 2. Positional accuracy of the terminals is controlled in this zone.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE	
SOT263B		5-lead TO-220	_		01-01-11	

Fig 18. Package outline SOT263B (TO-220)

8. Revision history

Table 7. Revision history

	-			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BUK7908-40AIE_3	20090217	Product data sheet	-	BUK71_7908_40AIE-02
Modifications:	guidelines • Legal texts	of this data sheet has be of NXP Semiconductors. have been adapted to the er BUK7908-40AIE sepa	e new company name w	here appropriate.
BUK71_7908_40AIE-02 (9397 750 12086)	20031024	Product data sheet	-	BUK71_7908_40AIE-01
BUK71 7908 40AIE-01	20030819	Product data sheet		

9. Legal information

9.1 Data sheet status

Document status [1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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BUK7908-40AIE

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